TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC74LCX16245AFT**

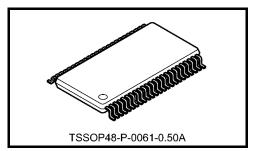
#### Low-Voltage 16-Bit Bus Transceiver with 5-V Tolerant Inputs and Outputs

The TC74LCX16245AFT is a high-performance CMOS 16-bit bus transceiver. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5-V supply environment for both inputs and outputs.

This 16-bit bus transceiver is controlled by direction control (DIR) inputs and output enable ( $\overline{OE}$ ) inputs which are common to each byte. It can be used as two 8-bit transceiver or one 16-bit transceiver. The direction of data transmission is determined by the level of the DIR inputs. The  $\overline{OE}$  inputs can be used to disable the device so that the busses are effectively isolated.

All inputs are equipped with protection circuits against static discharge.



Weight: 0.25 g (typ.)

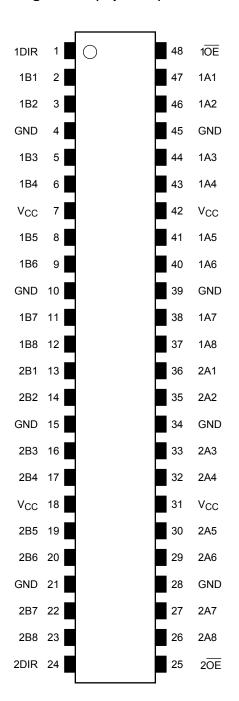
#### Features (Note)

- Low-voltage operation:  $V_{CC} = 2.0$  to 3.6 V
- High-speed operation:  $t_{pd} = 5.2 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Ouput current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: -500 mA
- Package: TSSOP
- Bidirectional interface between 5.0 V and 3.3 V signals
- Power-down protection provided on all inputs and outputs

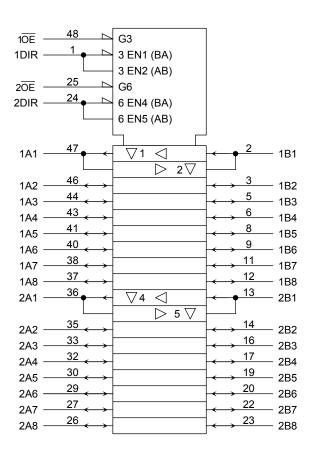
Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

All floating (high impedance) bus pins must have their input level fixed by means of pull-up or pull-down resistors.

#### Pin Assignment (top view)



## **IEC Logic Symbol**



## **Truth Table**

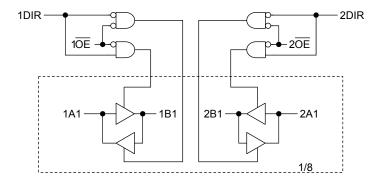
Inp	uts	Function		
1 <del>OE</del>	1DIR	Bus Bus 1A1-1A8 1B1-1B8		Outputs
L	L	Output Input		A = B
L	Н	Input Output		B=A
Н	Х	Z		Z

Inputs		Function		
2 <del>OE</del>	2DIR	Bus Bus 2A1-2A8 2B1-2B8		Outputs
L	L	Output Input		A = B
L	Н	Input Output		B = A
Н	Х	Z		Z

X: Don't care

Z: High impedance

## **System Diagram**





#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Power supply voltage	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage (DIR, $\overline{\text{OE}}$ )	V <sub>IN</sub>	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC bus I/O voltage	$V_{I/O}$	$-0.5$ to $V_{CC}$ + $0.5$	V
		(Note 3)	
Input diode current	I <sub>IK</sub>	-50	mA
Output diode current	I <sub>OK</sub>	±50 (Note 4)	mA
DC output current	I <sub>OUT</sub>	±50	mA
Power dissipation	$P_{D}$	400	mW
DC V <sub>CC</sub> /ground current per supply pin	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4:  $V_{OUT} < GND, V_{OUT} > V_{CC}$ 

#### **Operating Ranges (Note 1)**

Characteristics	Symbol	nbol Rating		
Power supply voltage	V <sub>CC</sub>	2.0 to 3.6	٧	
Fower supply voltage	VCC.	1.5 to 3.6 (Note 2)		
Input voltage (DIR, $\overline{OE}$ )	V <sub>IN</sub>	0 to 5.5	V	
Bus I/O voltage	V <sub>I/O</sub>	0 to 5.5 (Note 3)	V	
bus i/O voltage	V 1/O	0 to V <sub>CC</sub> (Note 4)	V	
Output current	I <sub>OH</sub> /I <sub>OI</sub>	±24 (Note 5)	mA	
Output current	IOH/IOL	±12 (Note 6)	ША	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 6:  $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$ 

Note 7:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



## **Electrical Characteristics**

## DC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics		Symbol	Symbol Test Condition			Min	Max	Unit
		·			V <sub>CC</sub> (V)			
Input voltage	H-level	V <sub>IH</sub>	_	_	2.7 to 3.6	2.0		V
input voltage	L-level	V <sub>IL</sub>	_	_	2.7 to 3.6		0.8	V
				I <sub>OH</sub> = -100 μA	2.7 to 3.6	V <sub>CC</sub> - 0.2	_	
	H-level	VoH	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -12 \text{ mA}$	2.7	2.2	_	
				I <sub>OH</sub> = -18 mA	3.0	2.4	_	
Output voltage				I <sub>OH</sub> = -24 mA	3.0	2.2	_	V
			V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	2.7 to 3.6	_	0.2	
	L-level	V/-		I <sub>OL</sub> = 12 mA	2.7	_	0.4	
	L-level	V <sub>OL</sub>		I <sub>OL</sub> = 16 mA	3.0	_	0.4	
				I <sub>OL</sub> = 24 mA	3.0	_	0.55	
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		2.7 to 3.6	_	±5.0	μА
3-state output OFF sta	ate current	I <sub>OZ</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = 0$ to 5.5 V		2.7 to 3.6	_	±5.0	μА
Power-off leakage cur	ge current I <sub>OFF</sub> V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		0	_	10.0	μΑ		
Quiescent supply current			V <sub>IN</sub> = V <sub>CC</sub> or GND		2.7 to 3.6	_	20.0	
		Icc	V <sub>IN</sub> /V <sub>OUT</sub> = 3.6 to 5.5 V		2.7 to 3.6	_	±20.0	μА
Increase in Icc per inp	ut	Δl <sub>CC</sub>	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V		2.7 to 3.6	_	500	

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## AC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Propagation delay time	t <sub>pLH</sub>	Figure 1, Figure 2	2.7	_	6.2	ns
Tropagation delay time	t <sub>pHL</sub>	rigule 1, rigule 2	$3.3 \pm 0.3$	1.5	5.2	
3-state output enable time	t <sub>pZL</sub>	Figure 1, Figure 3	2.7		7.5	ns
	t <sub>pZH</sub>		$3.3 \pm 0.3$	1.5	6.5	
3-state output disable time	t <sub>pLZ</sub>	Figure 1, Figure 3	2.7		7.0	ns
3-state output disable time	t <sub>pHZ</sub>	rigure 1, rigure 3	$3.3 \pm 0.3$	1.5	6.0	110
Output to output skew	t <sub>osLH</sub>	(Note)	2.7			ne
	t <sub>osHL</sub>	(Note)	$3.3 \pm 0.3$		1.0	ns

Note: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|)$ 

### **Dynamic Switching Characteristics**

(Ta = 25°C, input:  $t_r = t_f = 2.5$  ns,  $C_L = 50$  pF,  $R_L = 500$  Ω)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	٧
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	0.8	V

## **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	_	3.3	7	pF
Bus input capacitance	C <sub>I/O</sub>	_	3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	f <sub>IN</sub> = 10 MHz (Note	3.3	25	pF

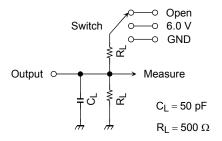
Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$ 

#### **AC Test Circuit**



Parameter	Switch
t <sub>pLH</sub> , t <sub>pHL</sub>	Open
t <sub>pLZ</sub> , t <sub>pZL</sub>	6.0 V
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND

Figure 1

#### **AC Waveform**

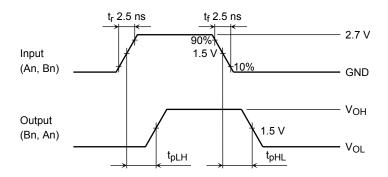


Figure 2 t<sub>pLH</sub>, t<sub>pHL</sub>

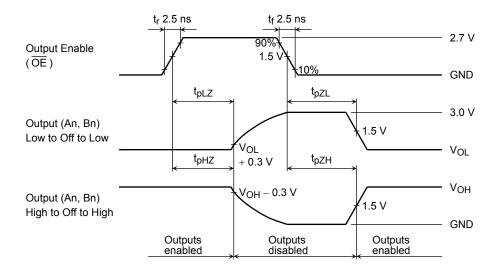


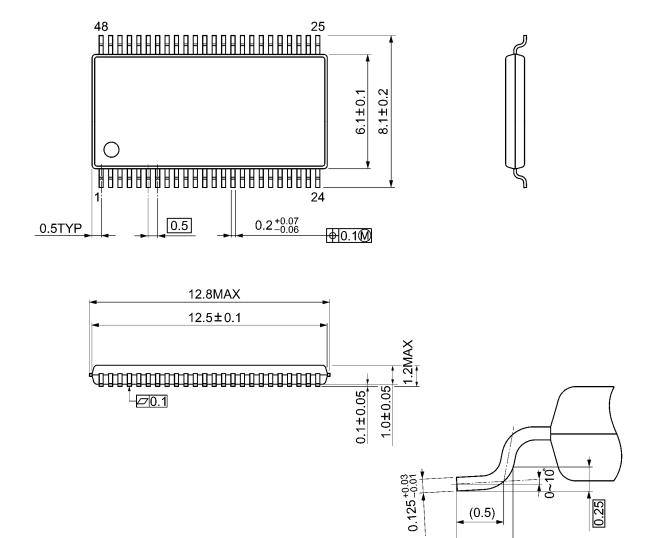
Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

(0.5)

0.45~0.75

## **Package Dimensions**

TSSOP48-P-0061-0.50A Unit: mm



Weight: 0.25 g (typ.)

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